PRODUCT SPECIFICATION

PRODUCT: CERAMIC DISC CAPACITOR SAFETY RECOGNIZED

TYPE: AH SERIES

CUSTOMER: _____

DOC. NO.: POE-D10-00-E-29

APPROVED BY CUSTOMER

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Record of change

Date	Version	Description	page
2008.6.3	1	1. D22-00-E-01(before) → POE-D10-00-E-01(1st edition)	
2008.8.22	2	1. Complete lead code 2. Add last SAP code " H" for halogen and Pb free , epoxy resin..	21 3
2008.12.12	3	1. Complete the 13th to 17th codes of SAP P/N. 2. Page layout adjustment.	4-5
2009.7.8	4	1. 1 Change PSA & POE logo to Walsin & POE logo. 2. Complete Marking statement. 3. Revised standard NO. of SEV, SEMKO, FIMKO, NEMKO, DEMKO and KEMA. 4. Revised recognized NO. of FIMKO, NEMKO, DEMKO and KEMA.	 10 12
2009.9.14	5	1. H0: 18.0+2.0/-1.5 revised to 18.0+2.0/-0 2. "Protrusion length": "+0.5to-1.0" revised to "2.0max (Or the end of lead wire may be inside the tape.)" 3. 3. Add "250V~" under the "UL" mark according to the product's marking.	9 9 10
2009.12.24	6	1. Marking 2. Correct X1 of recognized No by KTL. 3. Revised the Figure of impulse voltage test(Item 7.3.14) according to the standard IEC 60384-14 ed.3 4. Add "1AH" code for Y1:400V marking type.	10 11 14 4
2011.1.11	7	1. Review SAP P/N about diameter code: YU*AH561K100*→YU*AH561K080* 2. Delete "AT" taping type. 3. Add test item "Temperature Cycle " . 4. Add item 10 "Drawing of internal structure and material list"	6 4,5,8,9 14 19
2011.5.12	8	1. Review the safety standards approval and recognized no. 2. Delete "old P/N" 3. Add the special marking for P/N:YP*AH102K100	10 5~6 9
2012.1.30	9	1. Review the approval rated voltage of UL and the marking.	8~9
2012/4/6	10	1. In order to improve the traceability of the product, change the date code on capacitor body, new date code can trace back to production "Lot No."	8
2013/5/13	11	1. Review the Lead diameter φ from 0.60 +0.1/-0.05mm to 0.55+/-0.05mm 2. Add"3.1Norminal parts&3.2 special for surge parts" for "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter" 3. In order the customer to know the round time of manufacture, change the date code on capacitor body, new date code can know the month of manufacture. 4. Delete "No marked with " _" stand for Pb free". 5. Delete "When the TCC is Y5V(YV), there is a "F" between the "AH" and capacitance code." 6. Review the Solderability time from 2 ±0.5s to 5±0.5s	5,6,7 6 8 8 8 11
2013/10/16	12	1. Review the "Manufactured Date" to "Products ID" on the marking page 2. Delete "The marking can be printed on either one side or two side of coating body. "and add "for SAP part number 10-11 digits ≤ '07' products" to two sides and "for SAP part number 11-12 digits ≥ '08 products" to one side.	8 8
2014/11/5	13	1. Review the size of SL*AH820J*** from 080 to be 090. 2. Review the terminal position of the lead wire. 3. Review the product of ID, add the code "D" for the products of Dongguan Walsin Technology Electronics Co., Ltd. 4. Review the Operating Temperature Range, from "-25 to +125°C" to be "-40 to +125°C". 5. Review the minimum packing quantity of taping code AM. 6. Review the low temperature range from -25℃ to -40℃ for temperature cycle test.	6 7 8 11 15 13
2016/1/27	14	1. Review the Available lead code of Lead Configuration 2. Add the SAP P/N :YU*AH681M*. 3. Revised standard NO. of VDE, SEV, SEMKO, FIMKO, NEMKO and DEMKO.	5 6 9
2016/5/3	15	1. Delete 6 Pf~10 Pf for P/N CH*AH***D06＊＊, 12 Pf for P/N CH*AH120J06＊＊ and 15 Pf~27 Pf for P/N CH*AH***J07＊＊. 2. Add 10 Pf&12 Pf for P/N SL*AH***J06＊＊	6 6

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Record of change (continue)

Date	Version	Description	page
2016/11/3	16	1. Delete “CH” series.	4,6,10~13,18
2017/2/16	17	1. Add “C” code Pitch 12.5mm.	4,5
2017/3/10	18	1. Revise CQC Standard No.	10
2018/8/11	19	1. Revised standard NO. of VDE, SEV, SEMKO, FIMKO, NEMKO and DEMKO.	10
2019/2/25	20	1. Delete “3.2 Special design parts” for surge withstanding	6
2019/4/24	21	1. “Protrusion length”: “2.0max (Or the end of lead wire may be inside the tape.)” revised to “+0.5to-1.0 (Or the end of lead wire may be inside the tape.)” 2. Add “AS”& “AT” taping type. 3. Add “Soldering Recommendation”	7~8 8 19
2019/12/11	22	1. Review the Available lead code of Lead Configuration 2. Add “8.3 Label samples ”	5 15
2021/9/9	23	1. Delete Walsin & POE logo.	1
2022/4/18	24	1. Add Applied voltage in 9.1 Caution (Rating): 2. Add 9.3.4 List of substances that affect the insulation strength of coating	17 19
2023/5/10	25	1. Add the Special marking for P/N: YU1AH471M*/ YU1AH561M* /YU1AH681M*.	9
2023/5/26	26	1. Revised recognized No. of SEMKO and FIMKO.	10
2023/9/25	27	1. Review the bulk packing quantity of the code of 14th to15th ≧12	15
2024/7/10	28	1. Revised recognized No. of SEV, SEMKO and FIMKO.	10
2025/7/6	29	1. Revised recognized No. of SEV 2. Review the Drawing of Internal Structure and material list	10 21

Table of Contents

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1. Part number for SAP system:

(Ex.)	YU	0	AH	472	M	13	0	L	20	C	0	H
	(1)	(2)-1	(2)-1	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	(11)

(1)Temperature characteristic (identified code)

CODE	Temperature characteristic	Cap. Change
SL	SL	-1000~+350ppm/℃ (+20℃~+85℃)
YP	Y5P	±10%
YU	Y5U	-55% to +20%
YV	Y5V	-80% ~ +30%

(2)-1 Rated voltage(identified by 1-figure code)：0= X1:400V~/Y1:250V~, 1=X1:400V~/Y1:400V~

(2)-2 Type(identified by 2-figure code)：AH

(3)Capacitance (identified by 3-figure code):EX.221=220pF

(4)Capacitance tolerance (identified by code): J:±5%,K:±10%,M:±20%

(5)Nominal body diameter dimension (identified by 2-figure code)：06--Dmax7.0mm, 07--Dmax8.0mm...

(6)Internal code: 0--Normal, other code--Special control

(7)Lead Style：Refer to “2. Mechanical”.

(8)Packing mode and lead length (identified by 2-figure code)

Taping Code	Description
AM	Ammo box and product pitch：25.4 mm
AS	Ammo box and product pitch：15.0 mm (Only for the SAP part number 11-12 digits ≦ 10)
AT	Ammo box and product pitch：30.0 mm

Bulk Code	Description
03	Lead length ： 3.0mm
3E	Lead length ： 3.5mm
04	Lead length ： 4.0mm
4E	Lead length ： 4.5mm
20	Lead length ： 20mm

(9)Length tolerance

Code	Description	
A	±0.5 mm (only for kink lead type)	Short lead
B	±1.0 mm	Short lead
C	Min.	Long lead
D	Taping special purpose	Taping

(10)Pitch

Code	Description
0	10±1 mm
A	10±0.5 mm
C	12.5± 0.8 mm

(11)Epoxy Resin Code

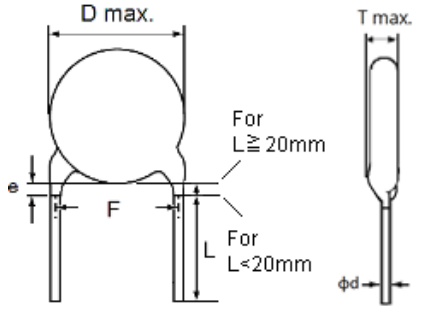
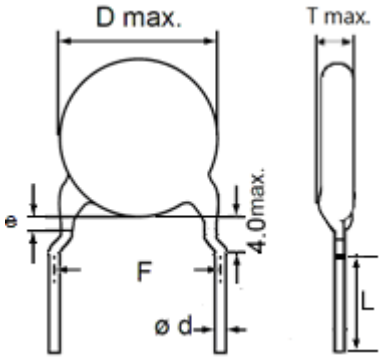
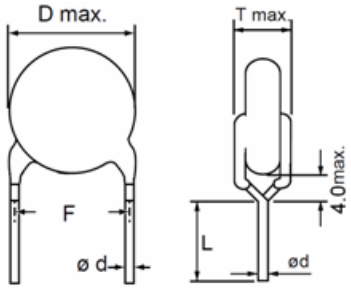
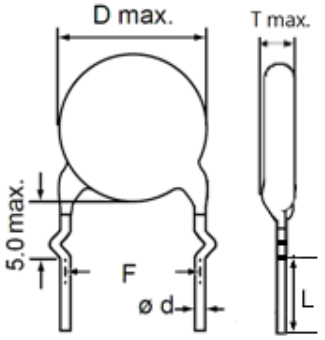
Code	Description
B	Halogen and Pb free, epoxy resin.
H	

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2. Mechanical:

Encapsulation：Epoxy resin, flammability UL94 V-0

Available lead code (unit: mm):

Lead type	SAP P/N (13-17)digits	Pitch (F)	Lead Length (L)	Packing	Lead Configuration
Lead style：L or B Type L or B Straight lead	L03B0	10 ± 1.0	3.0 ± 1.0	Bulk	
	L4EB0	10 ± 1.0	4.5 ± 1.0		
	L05B0	10 ± 1.0	5.0 ± 1.0		
	L03BC	12.5 ± 0.8	3.0 ± 1.0		
	L4EBC	12.5 ± 0.8	4.5 ± 1.0		
	L05BC	12.5 ± 0.8	5.0 ± 1.0		
	L20C0	10 ± 1.0	20 min.		
	L20CC	12.5 ± 0.8	20 min.		
	BAMD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	BASD0	10 ± 1.0			
	BATD0	10 ± 1.0			
Lead style：G Type G Straight lead	G03B0	10 ± 1.0	3.0 ± 1.0	Bulk	
	G4EB0	10 ± 1.0	4.5 ± 1.0		
	G05B0	10 ± 1.0	5.0 ± 1.0		
	GAMD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	GASD0	10 ± 1.0			
	GATD0	10 ± 1.0			
Lead style：D Type D Vertical kink lead	D03A0	10 ± 1.0	3.0 ± 0.5	Bulk	
	D3EA0	10 ± 1.0	3.5 ± 0.5		
	D04A0	10 ± 1.0	4.0 ± 0.5		
	D03AC	12.5 ± 0.8	3.0 ± 0.5		
	D3EAC	12.5 ± 0.8	3.5 ± 0.5		
	D04AC	12.5 ± 0.8	4.0 ± 0.5		
	DAMD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	DASD0	10 ± 1.0			
	DATD0	10 ± 1.0			
Lead style：X Type X Outside kink lead	X03A0	10 ± 1.0	3.0 ± 0.5	Bulk	
	X3EA0	10 ± 1.0	3.5 ± 0.5		
	X04A0	10 ± 1.0	4.0 ± 0.5		
	X05B0	10 ± 1.0	5.0 ± 1.0		
	X03AC	12.5 ± 0.8	3.0 ± 0.5		
	X3EAC	12.5 ± 0.8	3.5 ± 0.5		
	X04AC	12.5 ± 0.8	4.0 ± 0.5		
	X05BC	12.5 ± 0.8	5.0 ± 1.0		
	XAMD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	XATD0	10 ± 1.0			

***** Lead diameter Φd: 0.55 +/-0.05mm

*e (Coating **extension** on leads): 3.0mm Max for straight lead style, not exceed the kink for kink lead.

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3. Part numbering/T.C/Capacitance/ Tolerance/Diameter：

SAP P/N	T.C.	Capacitance(pF)	Tolerance	Dimension (unit:mm)			
				D(max.)	T(max.)	F	Φd
SL*AH***J060*	SL*	10,12,15,18,20,22,24, 27,30,33, 36, 39(pF)	±5%	7.0	5.0	10±1	0.55+/-0.05
SL*AH***J070*		47,50,51, 56,62(pF)		8.0			
SL*AH***J080*		68,75(pF)		9.0			
SL*AH***J090*		82,100(pF)		10.0			
YP*AH101K060*	Y5P	100 pF	±10%	7.0			
YP*AH151K060*		150 pF		7.0			
YP*AH221K060*		220 pF		7.0			
YP*AH331K060*		330 pF		7.0			
YP*AH471K070*		470 pF		8.0			
YP*AH561K080*		560 pF		9.0			
YP*AH681K080*		680 pF		9.0			
YP*AH102K100*		1000 pF		11.0			
YU*AH471M060*	Y5U	470 pF	±20%	7.0	5.0	10±1	0.55+/-0.05
YU*AH561M060*		560 pF		7.0			
YU*AH681M060*		680 pF		7.0			
YU*AH102M070*		1000 pF		8.0			
YU*AH152M080*		1500 pF		9.0			
YU*AH222M090*		2200 pF		10.0			
YU*AH332M110*		3300 pF		12.0			
YU*AH392M120*		3900 pF		13.0			
YU*AH472M130*		4700 pF		14.0			
YV*AH102M060*	Y5V	1000pF		7.0	5.5		
YV*AH152M070*		1500pF		8.0			
YV*AH222M080*		2200pF		9.0			
YV*AH332M100*		3300pF		11.0			
YV*AH472M110*		4700pF		12.0			

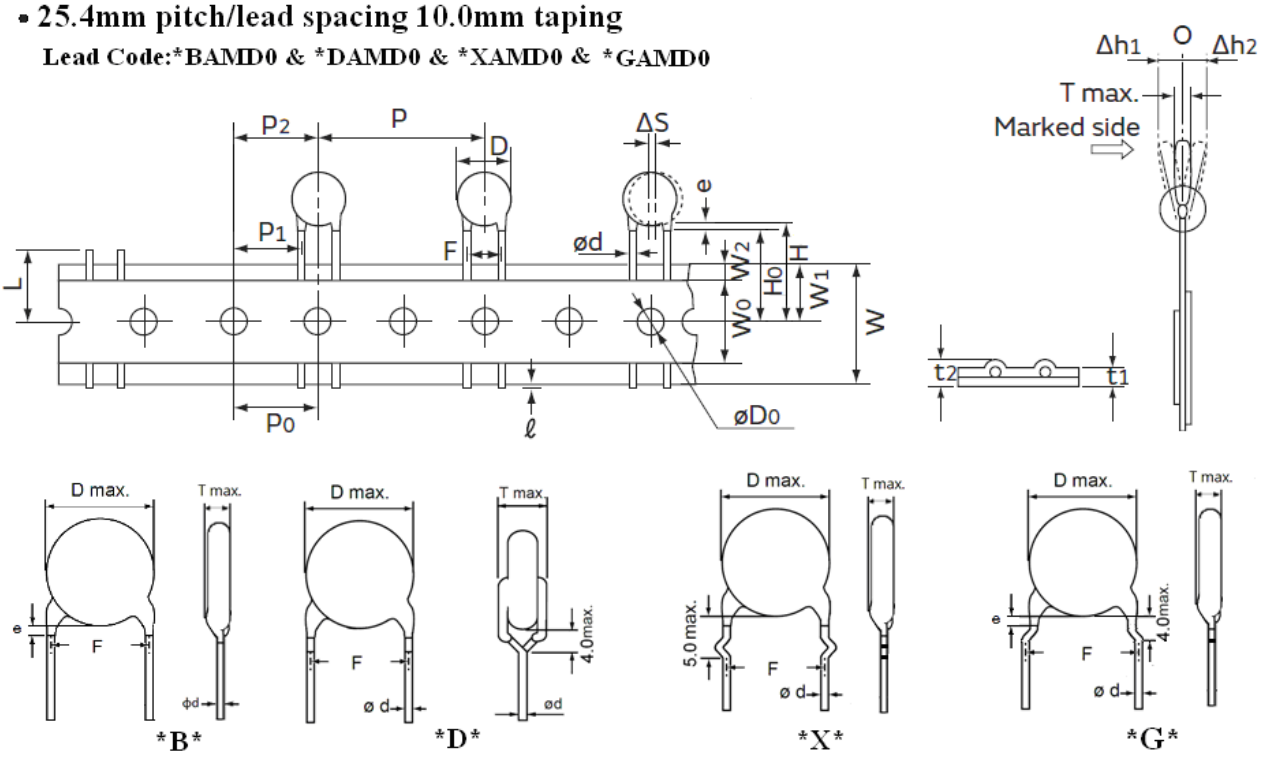
- The minimum thickness of coating (reinforced insulation) is 0.4mm.

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4. Taping Format:

- **25.4mm pitch/lead spacing 10.0mm taping**

Lead Code:*BAMD0 & *DAMD0 & *XAMD0 & *GAMD0

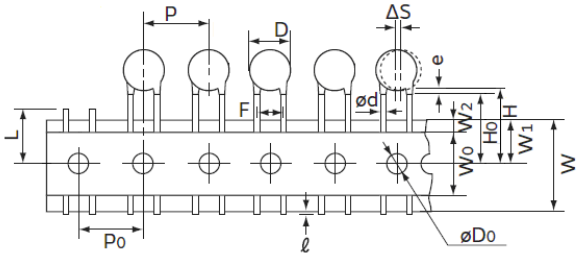


POE Part Number		*BAMD0 / *DAMD0 / *XAMD0/ *GAMD0
Item	Symbol	Dimensions(mm)
Pitch of component	P	25.4 ± 2
Pitch of sprocket	P0	12.7 ± 0.3
Lead spacing	F	10.0 ± 1.0
Length from hole center to component center	P2	12.7 ± 1.5
Length from hole center to lead	P1	7.7 ± 1.5
Body diameter	D	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"
Deviation along tape, left or right	Δ S	0 ± 2.0
Carrier tape width	W	18.0 +1/ -0.5
Position of sprocket hole	W1	9.0 ± 0.5
Lead distance between the kink and center of sprocket hole	H0	18.0 +2.0/-0 (For: *DAMD0 & *XAMD0 & *GAMD0)
Lead distance between the bottom of body and the center of sprocket hole	H	20.0+1.5/-1.0 (For: *BAMD0)
Length from the terminal of the lead wire to the edge of carrier tape	ℓ	+0.5 to -1.0 (or the end of lead wire may be inside the hole-down tape.)
Diameter of sprocket hole	D0	4.0 ± 0.2
Lead diameter	φd	0.55 ±0.05
Total tape thickness	t1	0.6 ± 0.3
Total thickness, tape and lead wire	t2	1.5 max.
Deviation across tape	Δ h1	2.0 max.
	Δ h2	2.0 max
Portion to cut in case of defect	L	11.0 max.
Hole-down tape width	W0	8.0 min
Hole-down tape distortion	W2	1.5 ± 1.5
Coating extension on leads	e	3.0mm max for straight lead style; Not exceed the kink leads for kink lead.
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"

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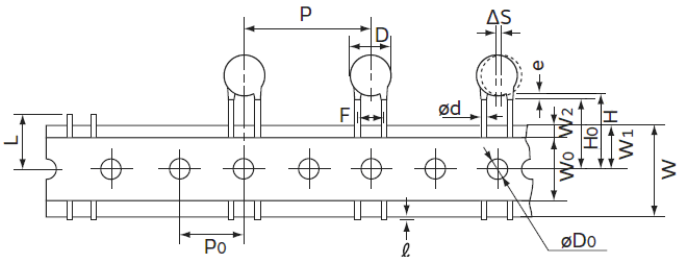
• 15mm pitch/lead spacing 10.0mm taping

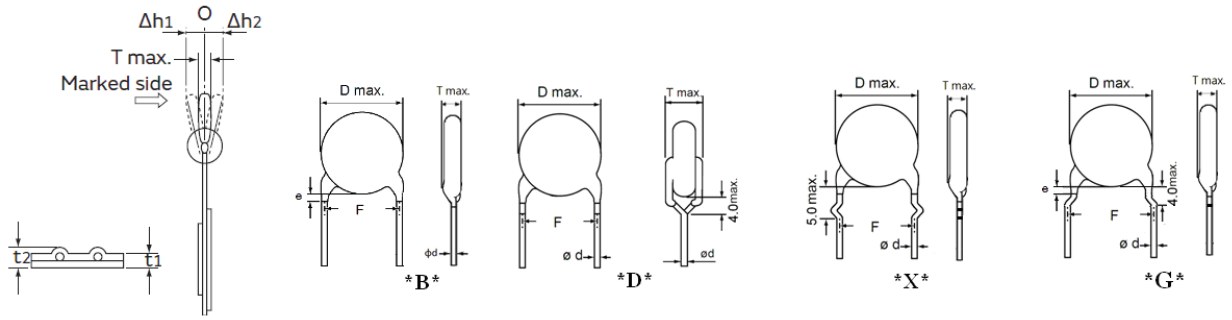
Lead Code: *BASD0 & *DASD0 & *GASD0



• 30mm pitch/lead spacing 10.0mm taping

Lead Code: *BATD0 & *DATD0 & *XATD0 & *GATD0





POE Part Number		*BASD0/*DASD0/*GASD0	*BATD0/*DATD0 /*GATD0/*XATD0
Item	Symbol	Dimensions(mm)	
Pitch of component	P	15.0±1	30.0 ± 2
Pitch of sprocket	P0	15.0±0.3	
Lead spacing	F	10.0±1.0	
Body diameter	D	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"	
Deviation along tape, left or right	Δ S	0 ± 2.0	
Carrier tape width	W	18.0 +1/ -0.5	
Position of sprocket hole	W1	9.0 ± 0.5	
Lead distance between the kink and center of sprocket hole	H0	18.0 +2.0/-0 (For: *DASD0 & *GASD0)	18.0 +2.0/-0 (For: *DATD0 & *GATD0 & *XATD0)
Lead distance between the bottom of body and the center of sprocket hole	H	20.0+1.5/-1.0 (For: *BASD0)	20.0+1.5/-1.0 (For: *BATD0)
Length from the terminal of the lead wire to the edge of carrier tape	ℓ	+0.5 to -1.0 (or the end of lead wire may be inside the hole-down tape.)	
Diameter of sprocket hole	D0	4.0 ± 0.2	
Lead diameter	φd	0.55 ±0.05	
Total tape thickness	t1	0.6 ± 0.3	
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape	Δ h1/Δ h2	2.0 max.	
Portion to cut in case of defect	L	11.0 max.	
Hole-down tape width	W0	8.0 min	
Hole-down tape distortion	W2	1.5 ± 1.5	
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink lead.	
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"	

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5. Marking:

1.Type Designation	**AH**		
2.Nominal Capacitance	Identified by 3-Figure Code. Ex. 47pF→"47"，470pF→"471"		
3.Capacitance Tolerance	J:±5%,K:±10%,M:±20%		
4.Company Name Code(Trade mark)	UK		
5. Products ID	Abbreviation ex.: Manufacture year: ← 5 C 6 1234 → Last 4 digits of lot no. 5:2025 6:2026 7:2027 ⋮ → Individual specification code → Manufacture month: 1:January 2:Feruary ⋮ 9:September O:October N:November D:December Manufactory: C:Pan overseas (Guangzhou) Epoxy resin code: "_": Haglogen and Pb free epoxy resin (For the last code "H" and "B" of SAP P/N)		
6.Approved Monogram:			
(1) VDE approval mark	IEC 60384-14 Class Code：X1：400V~，Y1：250V~ or 400V~		
(2) UL approval mark		(6) DEMKO approval mark	
(3) CSA approval mark		(7) FIMKO approval mark	
(4) SEMKO approval mark		(8) SEV approval mark	
(5) NEMKO approval mark		(9) CQC approval mark	

Normal marking		**Special marking**
Two sides **（for SAP part number 10-11 digits ≤ "07" products）**	**One side** **（for SAP part number 10-11 digits ≥ "08" products）**	**Two sides** **(For *AH471M* / *AH561M* / *AH681M*)**
0AH: UK AH101K X1:400V~ Y1:250V~ 5C61234 1AH: UK AH101K X1:400V~ Y1:400V~ 5C61234	0AH: UK AH472M X1:400V~ Y1:250V~ 5C61234 250V~ 1AH: UK AH472M X1:400V~ Y1:400V~ 5C61234 **YP*AH102K***** 0AH: UK AH102K 250V~ X1:400V~ Y1:250V~ 5C61234 1AH: UK AH102K X1:400V~ Y1:400V~ 5C61234	UK AH681M X1Y1 5C61234

* Marking by the laser.

* **"C"**：Marked with code " _ " stand for Halogen and Pb free epoxy resin.

* " • "：Individual specification code, it is added under the lot no.

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6. Scope:

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS DISK TYPE USED IN ELECTRONIC EQUIPMENT.

6.1Applicable safety standard

This specification applies to the VDE, SEV, SEMKO, FIMKO, NEMKO, DEMKO, KTL, UL, CSA approved ceramic capacitors disc type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC60384-14. "UL, CSA recognized capacitor for across-the-line, line-by-pass" and antenna-isolation.

6.2 Safety standards approval and recognized no.

Safety Standard	Standard No.	Subclass	w.v.	Recognized No.
UL	UL 60384-14 (2nd ed.)	X1	400VAC	E146544
		Y1	250VAC/400VAC	
CSA	IEC 60384-14 (ed.4) 2013	X1	400VAC	2347971
		Y1	250VAC/400VAC	
VDE (ENEC)	DIN IEC EN 60384-14 (VDE 0565-1-1):2024-10; EN IEC 60384-14:2023-03 IEC 60384-14:2023	X1	400VAC	40001804
		Y1	250VAC/400VAC	
ENEC (DEMKO)	EN IEC 60384-14:2023	X1	400VAC	ENEC-05460
		Y1	250VAC/400VAC	
SEV	EN IEC 60384-14:2023	X1	400VAC	25.0606
		Y1	250VAC/400VAC	
SEMKO	EN IEC 60384-14:2023	X1	400VAC	SE-S-2500705
		Y1	250VAC/400VAC	
FIMKO	EN IEC 60384-14:2023	X1	400VAC	FI_42172
		Y1	250VAC/400VAC	
NEMKO	EN IEC 60384-14:2023	X1	400VAC	PRJ0086795
		Y1	250VAC/400VAC	
DEMKO	EN IEC 60384-14:2023	X1	400VAC	D-11481
		Y1	250VAC/400VAC	
CQC	IEC60384-14:2013+AMDI:2016	X1:400VAC /Y1:400VAC		CQC03001003673
	GB/T6346.14-2023	X1:400VAC /Y1:250VAC		CQC11001055510
KTL	KC60384-1(2015-09) KC60384-14(2015-09)	X1	400VAC	SU03065-14004A
		Y1	250VAC	SU03065-14005A
	IEC 60384-14(ed.3)	Y1	400VAC	SU03065-14006A

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7. Specification and test method:

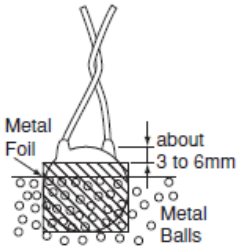
7.1 Operating Temperature Range: -40 to +125℃

7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature 15~35℃, relative humidity 45~75% and atmospheric pressure 860~1060hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature 20±2℃or25 ± 2℃, relative humidity 60~70% and atmospheric pressure 860~1060hpa.)

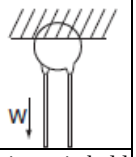
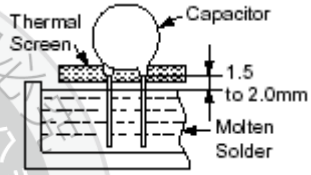
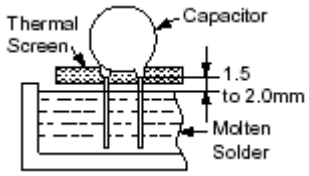
7.3 Performance:

No	Items		Performance	Testing method
7.3.1	Appearance And dimension		No visible defect, and dimensions are within specified range.	The capacitor should be visually inspected for evidence of defect. Dimensions should be measured with slide calipers.
7.3.2	Marking		To be easily legible.	The capacitor should be visually inspected.
7.3.3	Dielectric Strength	Between terminals	No failure.	The capacitors shall not be damage when AC4000V (rms.) are applied between the lead wires for 60sec. (Charge/Discharge current ≦ 50mA.) Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
		Body Insulation	No failure.	First, the terminals of the capacitor should be connected together. Then, a metal foil should be closely wrapped around the body of the capacitor to the distance of about 3 to 6mm from each terminal. Then, the capacitor should be inserted into a container filled with metal balls of about 1mm diameter. Finally, AC4000V (r.m.s.)<50/60Hz> is applied for 60 s between the capacitor lead wires and metal balls. (Charge/Discharge current ≦ 50mA.)  Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
7.3.4	Insulation Resistance	Between terminals	10000MΩ or more.	The insulation resistance shall be measured with DC500±50V within 60±5sec of charging. Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
7.3.5	Capacitance		Within specified tolerance.	Y5P&Y5U&Y5V: The capacitance should be measured at 20℃ with 1±0.2kHz and 1.0Vrms SL: The capacitance shall be measured at 25℃ with 1MHz±20% and1.0Vrms Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
7.3.6	Dissipation Factor(tanδ) or Q		Y5P、Y5U：D.F.≦2.5% Y5V：D.F.≦5.0% SL： 30pF&above:≧1000 Below 30PF:≧400+20×C	

※ “room condition” temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

※ "C" expresses nominal capacitance value (pF).

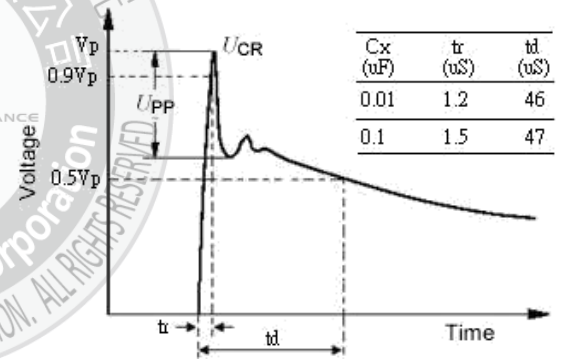
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<table>
<tr><th>No</th><th colspan="2">Items</th><th>Performance</th><th>Testing method</th></tr>
<tr><td>7.3.7</td><td colspan="2">Temperature Characteristic</td><td><table><tr><td>Char.</td><td>Capacitance Change</td></tr><tr><td>Y5P</td><td>Within ± 10%</td></tr><tr><td>Y5U</td><td>Within $\pm^{20}_{55}$%</td></tr><tr><td>Y5V</td><td>Within –80 ~ +30%</td></tr><tr><td>SL</td><td>-1000~+350 ppm/℃ (+20℃~+85℃)</td></tr></table></td><td>The capacitance measurement shall be made at each step specified in Table 1.<table><tr><td>Step</td><td>1</td><td>2</td><td>3</td><td>4</td><td>5</td></tr><tr><td>Temp.(℃)</td><td>+20±2</td><td>-25±2</td><td>+20±2</td><td>+85±2</td><td>+20±2</td></tr></table>Pre-treatment:
Capacitor shall be stored at 125±2℃ for 1hour, then placed at ※1room condition for 24±2hours before measurements.</td></tr>
<tr><td rowspan="2">7.3.8</td><td rowspan="2">Robustness of Terminations</td><td>Tensile</td><td>Lead wire shall not cut off capacitor shall not be broken.</td><td>As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N and keep it for 10±1 sec.
</td></tr>
<tr><td>Bending</td><td>Lead wire shall not cut off. Capacitor shall not be broken.</td><td>With the termination in its normal position, the specimen is held by its body in such a manner that the axis of the termination is vertical; a mass applying a force of 5N is then suspended from the end of the termination. The body of the specimen is then inclined, within a period of 2 to 3sec, through an angle of approximately 90° in the vertical plane and then returned to its initial position over the same period of time; this operation constitutes one bend. One bend immediately followed by a second bend in the opposite direction.</td></tr>
<tr><td rowspan="4">7.3.9</td><td rowspan="4">Soldering Effect (Non-Preheat)</td><td>Appearance</td><td>No marked defect.</td><td rowspan="4">As shown in figure, the lead wires should be immersed in solder of 350 ± 10 ℃ or 260 ± 5 ℃ up to 1.5 to 2.0 mm from the root of terminal for 3.5 ± 0.5 sec (10 ± 1 sec. for 260 ± 5 ℃).

Pre-treatment:
Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
Post-treatment:
Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td>I.R.</td><td>1000 MΩ min.</td></tr>
<tr><td>Dielectric Strength</td><td>Per item7.3. 3</td></tr>
<tr><td>Capacitance Change</td><td>Y5P,Y5U,Y5V：
Within ±10 %
SL：
Within±2.5% or ±0.25pF,Whichever is large.</td></tr>
<tr><td rowspan="4">7.3.10</td><td rowspan="4">Soldering Effect (On-Preheat)</td><td>Appearance</td><td>No marked defect.</td><td rowspan="4">First the capacitor should be stored at 120+0/-5 ℃ for 60 +0/-5 sec.
Then , as in figure , the lead wires should be immersed solder of 260+0/-5 ℃ up to 1.5 to 2.0 mm from the root of terminal for 7.5+0/-1 sec.

Pre-treatment:
Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
Post-treatment:
Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td>I.R.</td><td>1000 MΩ min.</td></tr>
<tr><td>Dielectric Strength</td><td>Per item 7.3.3</td></tr>
<tr><td>Capacitance Change</td><td>Y5P,Y5U,Y5V：
Within ±10 %
SL：
Within±2.5% or ±0.25pF,Whichever is large.</td></tr>
</table>

※ "room condition" temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

※ "C" expresses nominal capacitance value (pF).

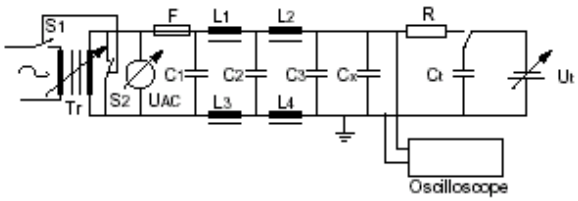
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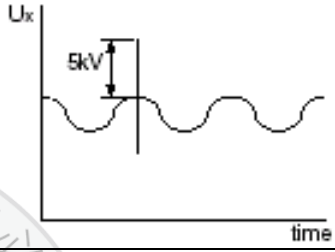
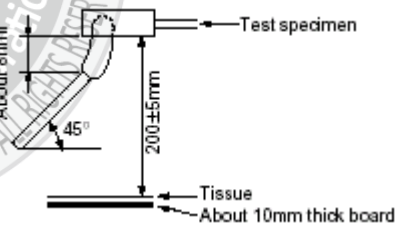
No	Items		Performance	Testing method
7.3.11	Solderability of Leads		Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.	The lead wire of capacitor should be dipped into molten solder for 5 ± 0.5 sec. The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires. Temp. of solder：Lead Free Solder (Sn-3Ag-0.5Cu) 245±5℃
7.3.12	Humidity (Under steady State)	Appearance	No marked defect.	Set the capacitor for 500±12hours at 40±2℃ in 90 to 95% relative humidity. Then capacitor shall be stored for 1 to 2 hours at ※1room condition. Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at※1room condition for 24±2hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.
		Capacitance Change	Y5P： Within ±10% Y5U： Within ±20% Y5V： Within ±30% SL： Within±2.5% or ±0.25pF,Whichever is large.	
		D.F.	Y5P,Y5U：5.0% max. Y5V：7.5% max.	
		Q	SL： Q≧100+10×C/3 (C＜30pF) Q≧ 200 (C≧30pF)	
7.3.13	Humidity Loading	I.R.	Y5P&Y5U&Y5V： 3000MΩ min. SL： 1000MΩ min.	Apply the rated voltage for 500±12 hours at 40±2℃ in 90 to 95% relative humidity Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at※1room condition for 24±2hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.
		Dielectric Strength	Per Item 7.3.3	
7.3.14	Life	Appearance	No marked defect.	Impulse Voltage Each individual capacitor shall be subjected to 8kV impulses for three times. After the capacitors are applied to life test.  Cx (uF) / tr (uS) / td (uS) 0.01 / 1.2 / 46 0.1 / 1.5 / 47 The specimen capacitors are placed in a circulating air oven for a period of 1000 hours. The air in the oven is maintained at a temperature of 125±3℃. Throughout the test, the capacitors are subjected to an AC425Vrms.(for 0AH type) or AC680Vrms.(for 1AH type) alternating voltage of mains frequency. Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at※1room condition for 24±2hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.
		Capacitance Change	Y5P&Y5U&Y5V： Within ±20% SL： Within±3% or ±0.3pF,Whichever is large.	
		I.R.	3000MΩ min. SL： 1000MΩ min.	
		Dielectric Strength	Per Item 7.3 3	

※ “room condition” temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

※ "C" expresses nominal capacitance value (pF).

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<table>
<tr><th>No</th><th colspan="2">Items</th><th>Performance</th><th>Testing method</th></tr>
<tr><td>7.3.15</td><td colspan="2">Active Flammability</td><td>The cheesecloth shall not be on fire.</td><td>The specimens shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5 sec. The UAC shall be maintained for 2 min after the last discharge.


C1,2 : 1μF±10% L1 to 4 : 1.5mH±20%
C3 : 0.033μF±5% 10kV 16A Rod core choke
Ct : 3μF±5% 10kV R : 100Ω±2%
Cx : Capacitor under test UAC : UR±5%
F : Fuse, Rated 10A UR : Rated Voltage
Ut : Voltage applied to Ct

</td></tr>
<tr><td>7.3.16</td><td colspan="2">Passive Flammability</td><td>The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.</td><td>The capacitor under test shall be held in the position which best promotes burning. Each specimen shall only be exposed once to flame. Time of exposure to flame: 30sec.
Length of flame : 12±1mm
Gas burner : Length 35mm min.
Inside Dia. : 0.5±0.1mm
Outside Dia. : 0.9mm max.
Gas : Butane gas Purity 95% min.

</td></tr>
<tr><td>7.3.17</td><td>Temperature Cycle</td><td>Appearance

I.R.
Dielectric strength</td><td>No marked defect

3000MΩ min.
Per Item 7.3.3</td><td>The capacitor should be subjected to 5 temperature cycles,
<Temperature Cycle time: 5cycles>
<table><tr><th>Step</th><th>Temperature(℃)</th><th>Time(min)</th></tr><tr><td>1</td><td>-40+0/-3</td><td>30</td></tr><tr><td>2</td><td>Room temp.</td><td>3</td></tr><tr><td>3</td><td>125+3/-0</td><td>30</td></tr><tr><td>4</td><td>Room temp.</td><td>3</td></tr></table>Pre-treatment:
Capacitor shall be stored at 125±2℃ for 1hour.then placed at※1room condition for 24±2hours.
Post-treatment:
Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td colspan="5"><table><tr><th>Char.</th><th>Cap. Change</th><th>DF / Q</th></tr><tr><td>SL</td><td>≦±5%</td><td>Q≧275+5/2C (C＜30pF)
Q≧350 (C≧30pF)</td></tr><tr><td>Y5P</td><td>≦±10%</td><td>DF≦5.0%</td></tr><tr><td>Y5U
Y5V</td><td>≦±20%</td><td>DF≦7.5%</td></tr></table></td></tr>
</table>

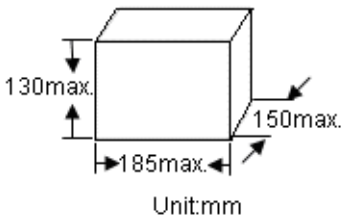
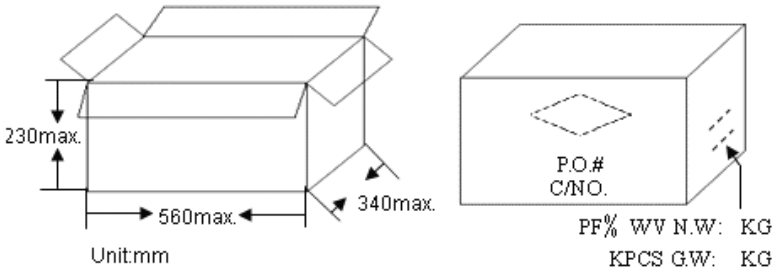
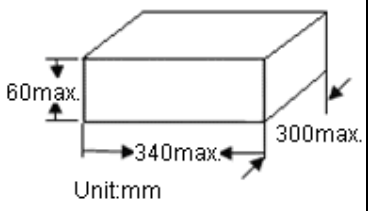
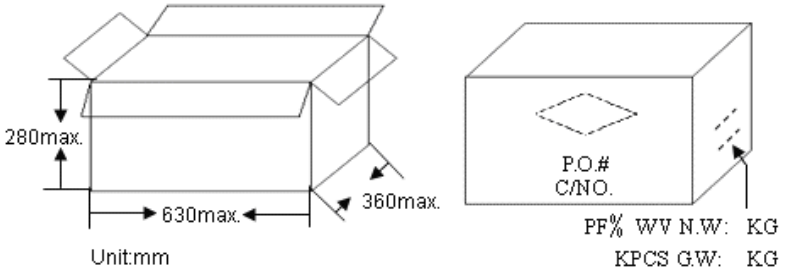
※ “room condition” temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

※ "C" expresses nominal capacitance value (pF).

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8.Packing Baggage：

8.1 Packing size:

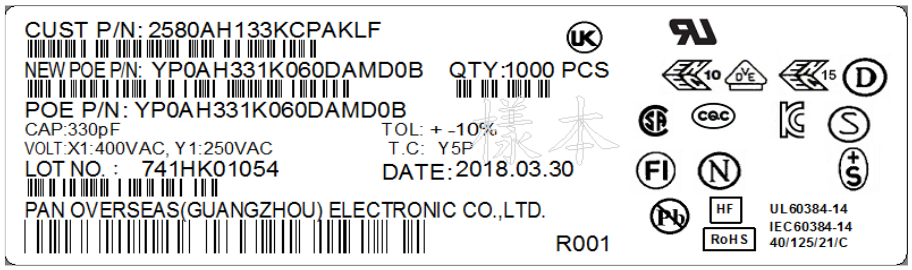
Type	Box	Carton
Bulk		
Ammo taping		

8.2 Packing quantity:

Packing type	The code of 14th to15th in SAP P/N	MPQ (Kpcs/Box)	Remark
Taping	AM (The size code≦11)	1	F=10mm (Code -17th"A" or "0")
	AM (The size code≧12)	0.5	
	AM(Code -17th"C")	0.5	F=12.5mm
	AS	1	
	AT	0.5	

Packing type	Lead length	Size code of 10th to 11th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box
Bulk	Long lead (L≧20mm)	06~12	0.5	1.5
		13	0.5	1
	Short lead (L＜20mm)	06~12	0.5	2
		13	0.5	1.5

8.3 Label samples



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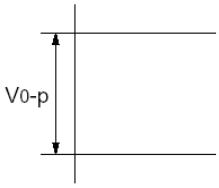
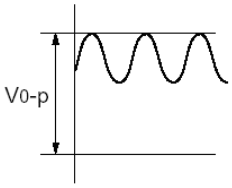
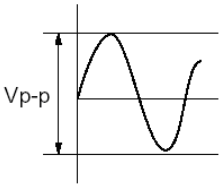
9. Notices:

9.1 Caution (Rating):

(1). Operating Voltage

Be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing this irregular voltage.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage
Positional measurement			

(2). Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

(3). Test condition for withstanding Voltage

I. Test Equipment

Test equipment for AC withstanding voltage shall be used with the performance of the wave similar to 50/60 Hz sine waves.

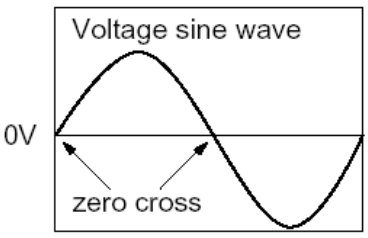
If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

II. Voltage Applied Method

When the withstanding voltage is applied, capacitor's lead or terminal shall be firmly connected to the output of the withstanding voltage test equipment, and then the voltage shall be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage shall be reduced to near zero, and then capacitor's lead or terminal shall be taken off the output of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.



ZERO CROSS is the point where voltage sine wave pass 0V.- See the right figure.

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III. Applied voltage

The voltages of Table shall be applied between the respective measuring points of 1 min for qualification approval and periodic testing and for a period of not less than 1 s for lot-by-lot quality conformance testing, a voltage proof test such as Test C shall be carried out only for qualification approval tests and periodic tests;

Attention is drawn to the fact that repetition of the voltage proof test by the user may damage the capacitor. If repetition of the voltage proof test is made by the user, the applied voltage should not be greater than 66 % of the test voltage specified in Table .

Table –Voltage proof

Class	Range of rated voltages	Test A	Test B or Test C
X1	≤1 000 V	4,3 *U*R (d.c.) c	2 *U*R + 1 500 V (a.c.) with a minimum of 2 000 V (a.c.) a
Y1	≤500 V	4 000 V (a.c.)	4 000 V (a.c.)
a For Delta and T-connected capacitor units according to Figures 5b and 5c, the test voltage for terminals to case shall be the appropriate test voltage for the Y-capacitors. b The *U*R in this d.c. test is the rated a.c.voltage value.			

Note:

Test A – Between terminations

Test B – Internal insulation

Test C – External insulation (applicable only to insulated capacitors in nonmetallic case or in insulated metal case)

Figure 5b – Delta by-pass capacitor (in metallic housing)

Figure 5c – Example of a T-connected by-pass capacitor (in non-metallic housing)

Figure 5b

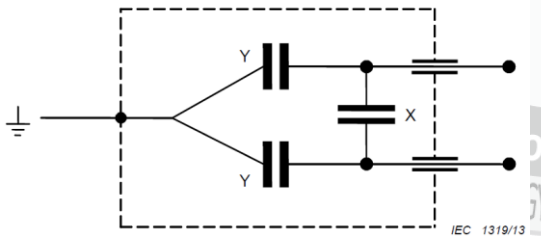
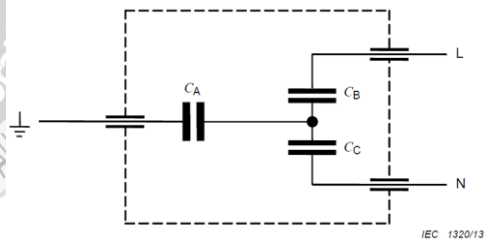


Figure 5c



***For capacitors with non-metallic housings, the earth connection is brought out as a separate termination as is shown in Figure 5c.**

(4). Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

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9.2 Caution (Storage and operating condition):

Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed –10 to 40 degrees centigrade and 15 to 85 % for 6 months maximum and use within the period after receiving the capacitors.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.3 Caution (Soldering and Mounting):

9.3.1 Vibration and impact:

Do not expose a capacitor or its leads to excessive shock or vibration during use.

9.3.2 Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage: 50W max.

Soldering time: 3.5 sec. max.

9.3.3 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time:5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

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9.3.4 List of substances that affect the insulation strength of coating：

Epoxy resin solvent

Category	Model		
Ketone	Acetone	Butanone	Cyclohexanone
Esters	Ethyl acetate	Dibutyl phthalate	
Chlorinated hydrocarbons	Dichloromethane		

Epoxy resin thinner

Category		Model	
Reactive diluentactivated thinner	Simple function group	HK-66 (Alkyl glycidyl ether)	
		501 (Butyl glycidyl ether)	
		690 (Phenyl Glycidyl Ether)	
		AGE (C12-14Aliphatic Polyalcohol Glycidyl Ether)	
		692 (Benzyl Glycidyl Ether)	
	Two functional groups	D-678（Neopentyl glycol diglycidyl ether）	
		622 (1,4-Butanediol diglycidyl ether)	
		669 (Ethylene glycol diglycidyl ether)	
		X-632 (Polypropylene glycol diglycidyl ether)	
		X-652 (1,6-Hexadiol diglycidyl ether)	
		D-691Epoxypropane o-methylphenyl ether	
Non-activated thinner		Anhydrous ethanol	Toluene
		Ethyl acetate	Dimethylbenzene
		Dimethyl formamide	Butyl acetate
		Acetone	Styrene
		Polyol	Benzyl alcohol

Note: The above substances should not contact the coating of the product body, otherwise it will affect the insulation strength of the product

9.4 Caution (Handling):

Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

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10. Soldering Recommendation:

10.1 Wave Soldering Profile:

- Temperature conditions of the flow is recommended as shown in the chart
- Must implement the pre-heat
- Maximum peak flow temperature is recommended 265℃
- Time " T " implement in the chart recommended within 20 sec. it temperature exceed 200℃
- Take care with the flow solder not to touch the capacitor body directly at mounting

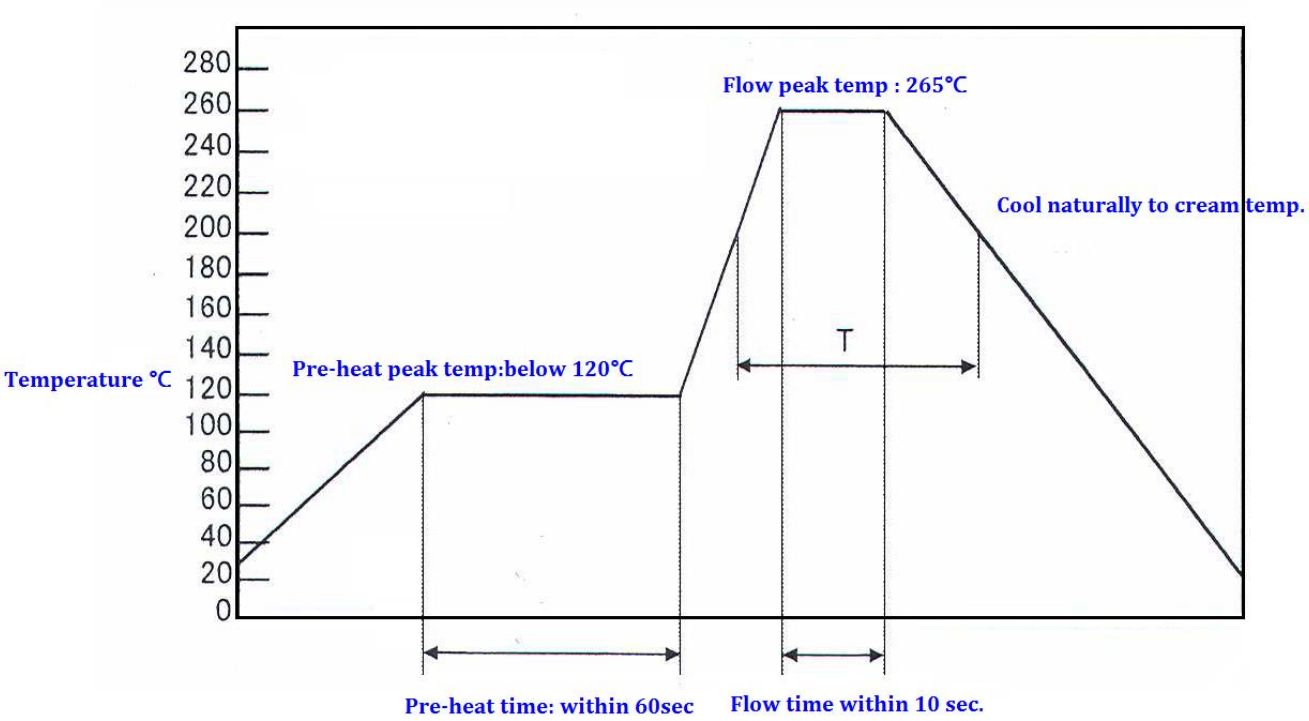


Chart to show flow recommended temp

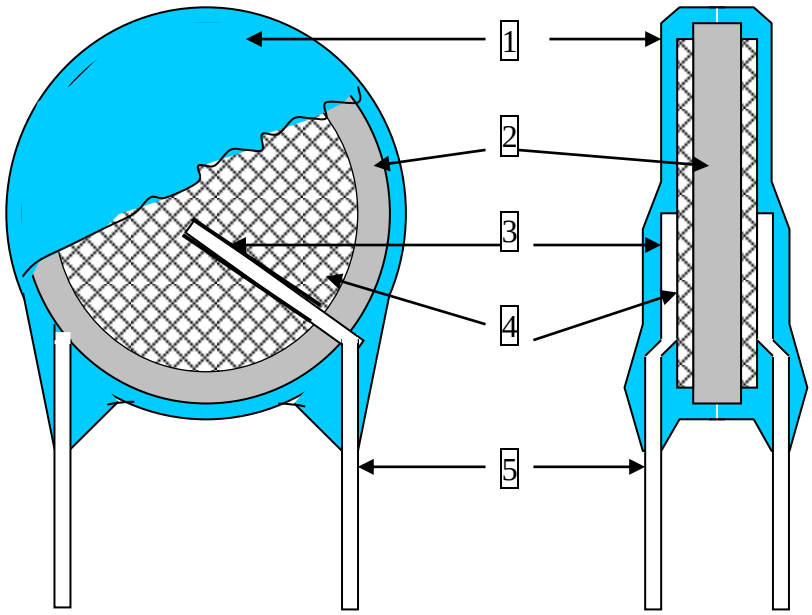
10.2 Recommended Reworking Conditions with Soldering Iron：

- Temperature of iron-tip: 400 degrees C. max.
- Soldering iron wattage: 50W max.
- Soldering time: 3.5 sec. max.
- Distance from coating body: 2 mm (min.)

10.3 Reflow-Soldering：Lead Ceramic Cap. should not be soldered by reflow-soldering.

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11. Drawing of internal structure and material list:



Remarks:

No.	Material	Description
1	Insulation Coating	Epoxy resins (Conforming to UL94V-0 standard) Type No.: confidential
2	Dielectric Element	Ceramic
3	Solder	Tin-Silver alloy
4	Electrodes	Silver [Ag]
5	Leads wire	Solder coated CP wire (Solder : Tin-Silver alloy)

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